

2SB1434

Silicon PNP epitaxial planer type

For low-frequency output amplification

Complementary to 2SD2177

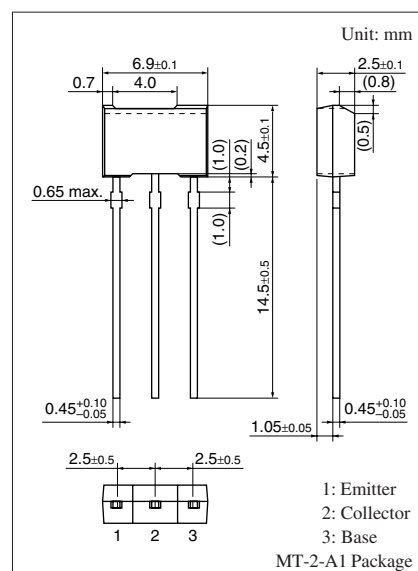
■ Features

- Low collector-emitter saturation voltage $V_{CE(sat)}$
- Allowing supply with the radial taping

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V_{CBO}	-50	V
Collector-emitter voltage (Base open)	V_{CEO}	-50	V
Emitter-base voltage (Collector open)	V_{EBO}	-5	V
Collector current	I_C	-2	A
Peak collector current	I_{CP}	-3	A
Collector power dissipation *	P_C	1	W
Junction temperature	T_j	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

Note) *: Print circuit board: Copper foil area of 1 cm^2 or more, and the board thickness of 1.7 mm for the collector portion



■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-base voltage (Emitter open)	V_{CBO}	$I_C = -10\text{ }\mu\text{A}$, $I_E = 0$	-50			V
Collector-emitter voltage (Base open)	V_{CEO}	$I_C = -1\text{ mA}$, $I_B = 0$	-50			V
Emitter-base voltage (Collector open)	V_{EBO}	$I_E = -10\text{ }\mu\text{A}$, $I_C = 0$	-5			V
Collector-base cutoff current (Emitter open)	I_{CBO}	$V_{CB} = -20\text{ V}$, $I_E = 0$			-0.1	μA
Forward current transfer ratio	h_{FE1}^{*2}	$V_{CE} = -2\text{ V}$, $I_C = -200\text{ mA}$	120		340	—
	h_{FE2}^{*1}	$V_{CE} = -2\text{ V}$, $I_C = -1\text{ A}$	60			
Collector-emitter saturation voltage *1	$V_{CE(sat)}$	$I_C = -1\text{ A}$, $I_B = -50\text{ mA}$		-0.2	-0.3	V
Base-emitter saturation voltage *1	$V_{BE(sat)}$	$I_C = -1\text{ A}$, $I_B = -50\text{ mA}$		-0.85	-1.20	V
Transition frequency	f_T	$V_{CB} = -10\text{ V}$, $I_E = 50\text{ mA}$, $f = 200\text{ MHz}$		110		MHz
Collector output capacitance (Common base, input open circuited)	C_{ob}	$V_{CB} = -10\text{ V}$, $I_E = 0$, $f = 1\text{ MHz}$		40	60	pF

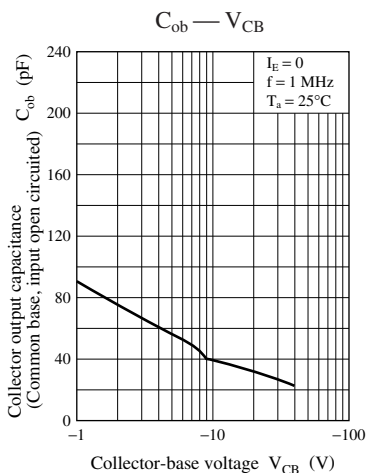
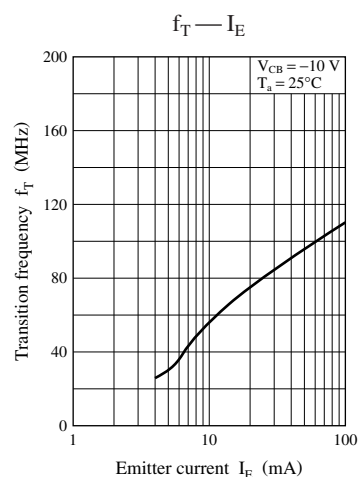
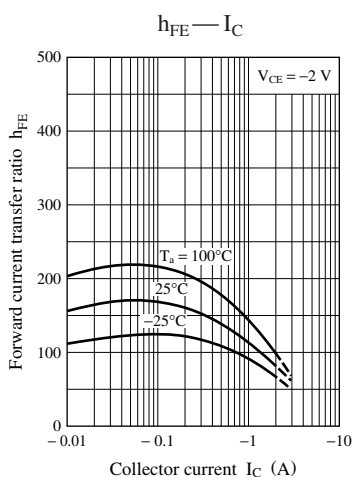
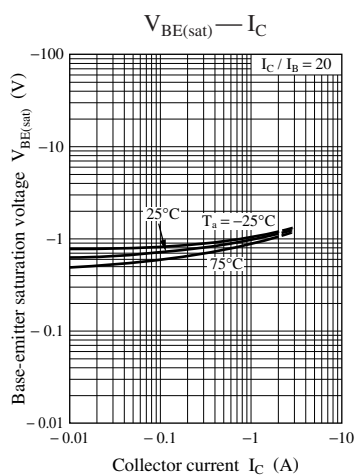
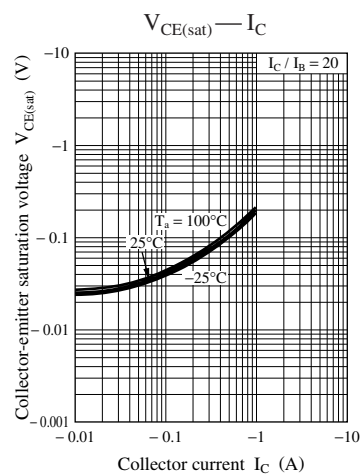
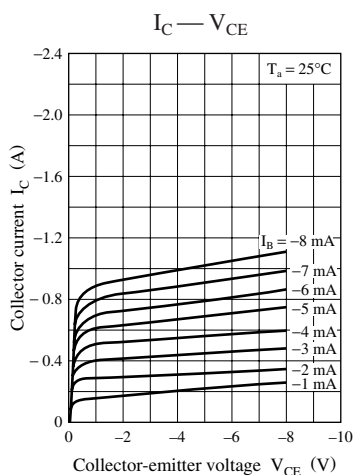
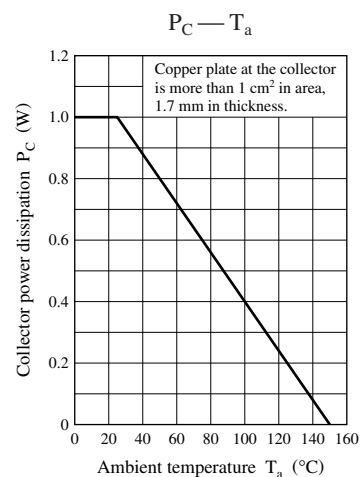
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. *1 : Pulse measurement

*2 : Rank classification

Rank	R	S	No-rank
h_{FE1}	120 to 240	170 to 340	120 to 340

Product of no-rank is not classification is not marked.



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